### **General Description**

The SJH015N06 uses SGT technology to provide excellent  $R_{DS(ON)}$ , low gate charge and fast switching characteristics. This device is suitable for use as a wide variety of applications.

### **Features**

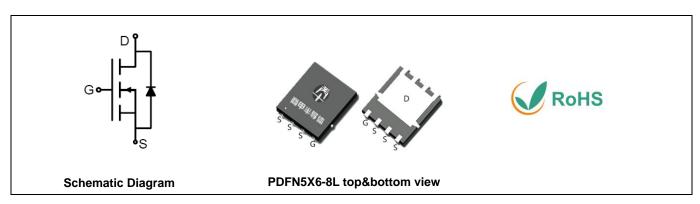
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handing capability
- Lead free product is acquired

### **Application**

- DC/DC Converter
- Load Switching
- Power Management

### **Key Performance Parametes**

Parameter	Value	Unit
V <sub>DS</sub>	60	V
R <sub>DS(ON)_TYP</sub>	1.8	mΩ
I <sub>D</sub>	172	Α
Q <sub>G</sub>	94.4	nC



### **Package Marking and Ordering Information**

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJH015N06	SJH015N06	PDFN5X6-8L	Tape	\	\	5000 Pcs

Table 1. Absolute Maximum Ratings (T<sub>C</sub>=25℃ unless otherwise noted)

Symbol	Parameter	Limit	Unit
$V_{DS}$	Drain-Source Voltage (V <sub>GS</sub> =0V)	60	V
V <sub>GS</sub>	Gate-Source Voltage (V <sub>DS</sub> =0V)	±20	V
1-	Drain Current-Continuous(Tc=25℃)	172	А
I <sub>D</sub>	Drain Current-Continuous(T <sub>C</sub> =100℃)	109	А
I <sub>DM</sub> (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	688	А
D-	Maximum Power Dissipation(Tc=25 $^{\circ}\mathrm{C}$ )	119	W
P <sub>D</sub>	Maximum Power Dissipation(Tc=100°C)	48	W
Eas	Avalanche energy (Note 2)	756	mJ
TJ, Tstg	Operating Junction and Storage Temperature Range	-55 To 150	${\mathfrak C}$

#### Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
Rejc	Thermal Resistance, Junction-to-Case		1.05	°C/W



Table 3. Electrical Characteristics (T<sub>J</sub>=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off States	•					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	60			V
	7 0 1 1/1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V T <sub>J</sub> =25°C			1	μΑ
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V T <sub>J</sub> =125℃			100	μΑ
Igss	Gate-Body Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V			±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250µA	1		2.5	V
<b>g</b> FS	Forward Transconductance	V <sub>DS</sub> =5V, I <sub>D</sub> =20A		54		S
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =20A T <sub>J</sub> =25°C		1.8	2.3	mΩ
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance	V <sub>GS</sub> =4.5V, I <sub>D</sub> =20A T <sub>J</sub> =25℃		2.6	3.5	mΩ
Dynamic Chara	octeristics			•		•
Ciss	Input Capacitance			6312		pF
Coss	Output Capacitance	V <sub>DS</sub> =30V,V <sub>GS</sub> =0V, f=1.0MHz		1679		pF
Crss	Reverse Transfer Capacitance			39.6		pF
Rg	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1.0MHz		1.8		Ω
Switching Para	meters			•		•
t <sub>d(on)</sub>	Turn-on Delay Time			19.8		nS
t <sub>r</sub>	Turn-on Rise Time	V <sub>GS</sub> =10V, V <sub>DS</sub> =30V,		14.8		nS
$t_{d(off)}$	Turn-Off Delay Time	R <sub>L</sub> =1.5Ω, R <sub>GEN</sub> =6Ω		77.2		nS
$t_f$	Turn-Off Fall Time			20.4		nS
$Q_g$	Total Gate Charge			94.4		nC
$Q_{gs}$	Gate-Source Charge	V <sub>GS</sub> =10V, V <sub>DS</sub> =30V, I <sub>D</sub> =20A		17.2		nC
$Q_{gd}$	Gate-Drain Charge			13.2		nC
Source-Drain D	liode Characteristics			•		•
I <sub>SD</sub>	Source-Drain Current (Body Diode)				172	А
V <sub>SD</sub>	Forward on Voltage (Note 3)	V <sub>GS</sub> =0V, I <sub>S</sub> =20A			1.2	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> =20A, dI/dt=100A/μs		65.8		ns
Qrr	Reverse Recovery Charge	Ir=20A, dI/dt=100A/μs		82.3		nC

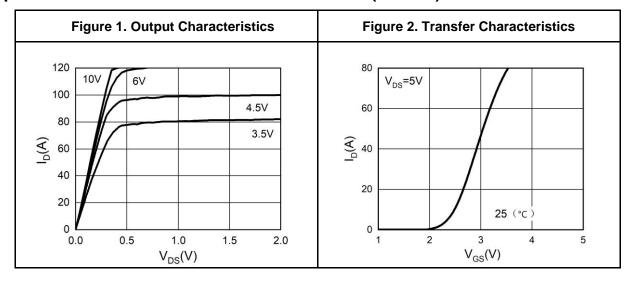
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

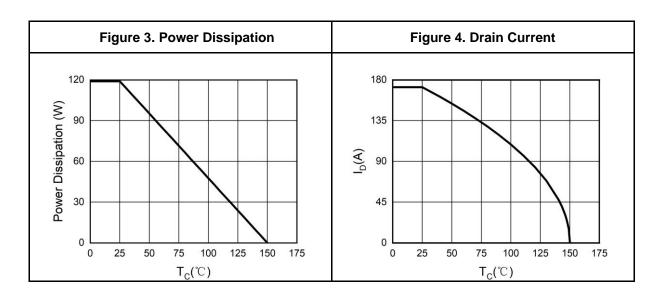
Notes 2.E<sub>AS</sub> condition:  $T_J=25^{\circ}C$ ,  $V_{DD}=40V$ ,  $V_G=10V$ ,  $Rg=25\Omega$ , L=0.5mH.

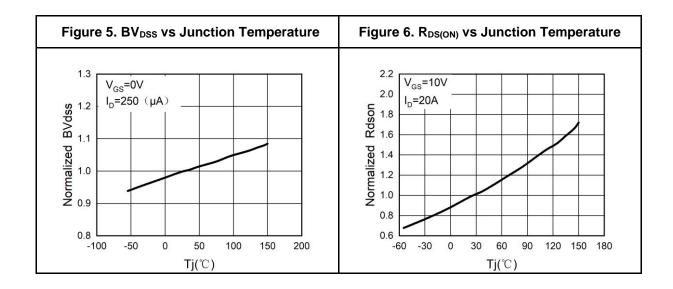
Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.



# **Typical Electrical And Thermal Characteristics (Curves)**

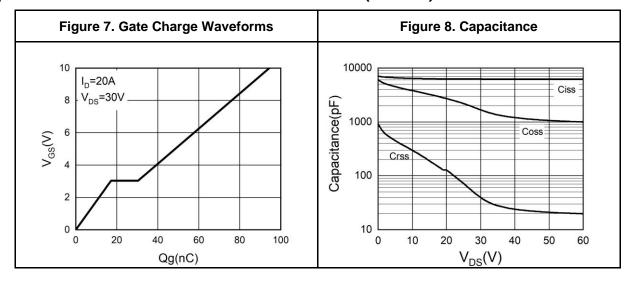


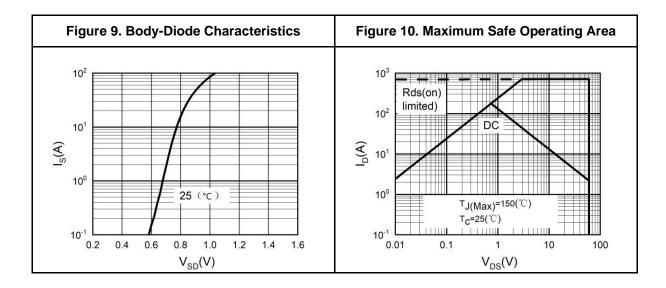




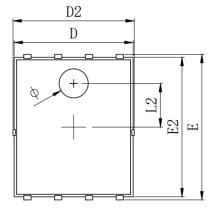


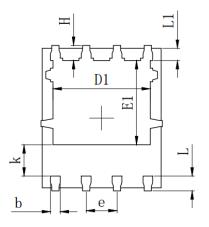
### **Typical Electrical And Thermal Characteristics (Curves)**



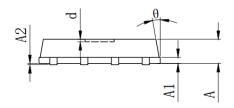


# PDFN5X6 Package Information





SYMBOL	MILLIMETER			
SYMBUL	MIN	MAX		
A	0. 900	1.000	1. 100	
A1		0. 254 REF.		
A2		0~0.05		
D	4. 824	4. 900	4. 976	
D1	3. 910	4. 010	4. 110	
D2	4. 924	5. 000	5. 076	
E	5. 924	6.000	6.076	
E1	3. 375	3. 475	3. 575	
E2	5. 674	5. 750	5. 826	
b	0. 350 0. 400 0. 45			
e		1.270 TYP.		
L	0. 534	0.610	0. 686	
L1	0. 424	0.500	0. 576	
L2	1.800 REF.			
k	1. 190 1. 290 1. 3		1. 390	
Н	0. 549	0. 625	0. 701	
θ	8°	10°	12°	
ф	1.100	1. 200	1.300	
d			0. 100	



Cumbal	MILLIMETER			
Symbol	Min.	Тур.	Max.	
А	0.900	1.000	1.100	
A1		0.254 REF.		
A2		0~0.05		
D	4.824	4.900	4.976	
D1	3.910	4.010	4.110	
D2	4.924	5.000	5.076	
E	5.924	6.000	6.076	
E1	3.375	3.475	3.575	
E2	5.674	5.75	5.826	
b	0.350	0.400	0.450	
е	1.270 TYP.			
L	0.534	0.610	0.686	
L1	0.424	0.500	0.576	
L2		1.800 REF.		
k	1.190	1.290	1.390	
Н	0.549	0.625	0.701	
θ	8°	10°	12°	
Ф	1.100	1.200	1.300	
d			0.100	

#### Attention

This product described in this document can not be used in life support devices or systems, aircraft's control systems, and other applications whose failure can be reasonably expected to result in serious physical and/or material damage, apart from that when an application agreement is signed between customer and Wuxi Shangjia Semiconductor

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